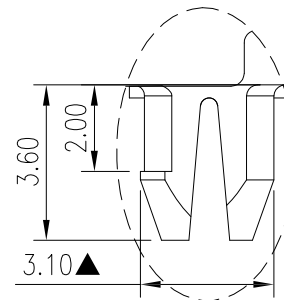
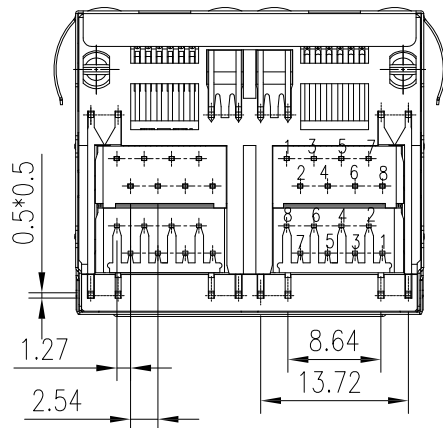
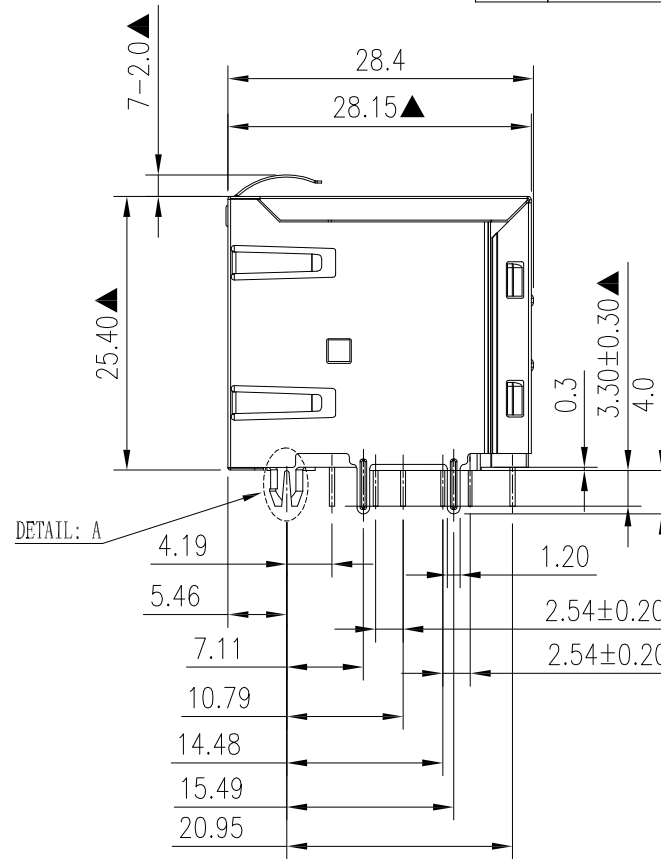
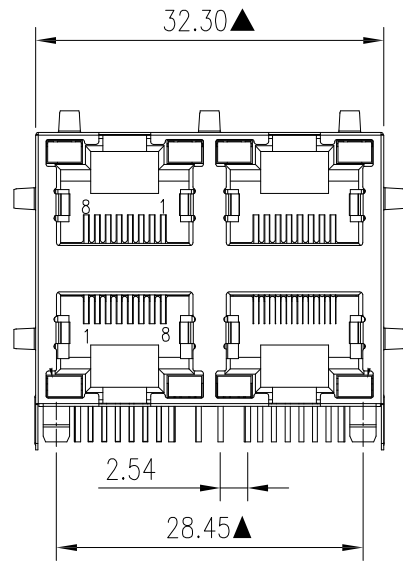
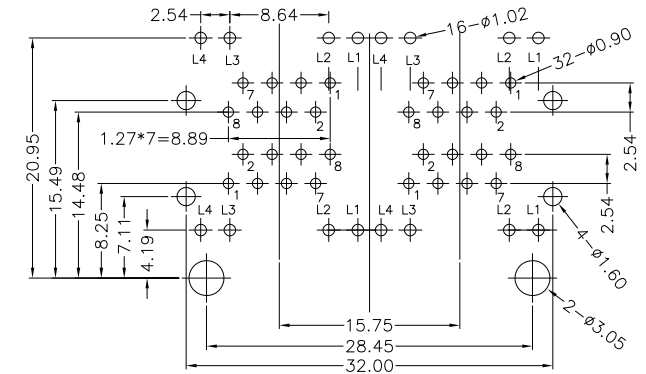


GP Component

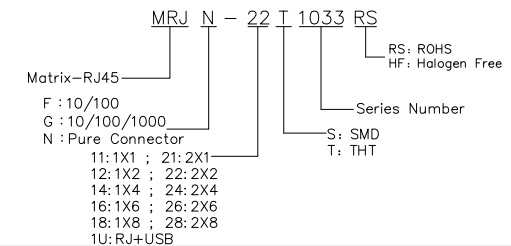
REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
AO			Initial	2019/06/25	Phebe Su

DETAIL: A
SCALE 4:1RECOMMENDED PCB LAYOUT(TOP SIDE)
TOLERANCE ±0.05

NOTES:

- MATERIAL:
HOUSING:PA46,UL94V-0,BLACK
CONTACT:PHOSPHOR BORNZE,T=0.35, GOLD 3u" ON CONTACT AREA,
MATTE TIN ON SOLDERTAIL.
SHELL:COPPER ALLOY, NICKEL 30u" OVERALL
- OPERATING TEMPERATURE: -40°C ~ +85°C
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS
PART 68, SUBPART F

ORDER INFORMATION:



Matrix Electronics Co.,Ltd

TOLERANCE: X:X X:XX X:XXX X:±2°	DESIGN BY : Phebe Su CHECKED BY: Vicky Hsieh APPROVED BY1: Richard Hsieh APPROVED BY2: Richard Hsieh	DATE : 2019/06/25 DATE : 2019/06/25 DATE : 2019/06/25 DATE : 2019/06/25	PART NAME: RJ45 2X2 CONN,W/LED PART NO. MRJN-22T1033RS MOLD NO. NA DRAW NO. SHEET NO.
UNIT: mm [inch] SCALE:1:1 SIZE:A4			1 OF 1